

ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage (V_{CC})	–0.3 to 100V
SENSE, PWRGD	–0.3 to 100V
GATE Voltage (Note 2)	–0.3V to $V_{CC} + 10V$
GATE Maximum Current	200 μ A
V_{OUT}	–3V to 100V
FB, UV, OPEN	–0.3 to 44V
OV	–0.3 to 18V
RETRY	–0.3 to 15V
TIMER Voltage	–0.3V to 4.3V
Maximum Input Current (TIMER)	100 μ A
Operating Temperature	
LT4256-3C	0°C to 70°C
LT4256-3I	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW GN PACKAGE 16-LEAD PLASTIC SSOP $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 130^{\circ}\text{C/W}$	ORDER PART NUMBER LT4256-3CGN LT4256-3IGN GN PART MARKING 42563 42563I
Order Options Tape and Reel: Add #TR Lead Free: Add #PBF Lead Free Tape and Reel: Add #TRPBF Lead Free Part Marking: http://www.linear.com/leadfree/	

Consult LTC Marketing for parts specified with wider operating temperature ranges.
Note: NC is a pin that is "Not Connected."

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}\text{C}$. $V_{CC} = 48V$ unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{CC}	Operating Voltage	●	10.8		80	V
I_{CC}	Operating Current			1.8	3.9	mA
V_{UVLH}	Undervoltage Threshold	V_{CC} Low-to-High Transition ●	3.96	4	4.04	V
V_{UVHYS}	Hysteresis		0.25	0.4	0.55	V
I_{INUV}	UV Input Current	$UV \geq 1.2V$ $UV = 0V$		–0.1 –1.5	–1 –3	μ A μ A
V_{UVRTH}	Fault Latch Reset Threshold Voltage	●	0.4	0.85	1.2	V
V_{OVLH}	Overvoltage Threshold	V_{CC} Low-to-High Transition ●	3.96	4	4.04	V
V_{OVHYS}	Hysteresis		0.25	0.4	0.55	V
I_{INOV}	OV Input Current	$0V \leq OV < 7V$		0.1	1	μ A
V_{OPEN}	Open-Circuit Voltage Threshold ($V_{CC} - V_{SENSE}$)	●	1.5	3	6.5	mV
V_{OLOPEN}	OPEN Output Low Voltage	$I_O = 2mA$ $I_O = 5mA$		0.20 0.75	0.5 1.3	V V
I_{INOPEN}	Leakage Current	$V_{OPEN} = 5V$		0.1	1	μ A
$V_{SENSETRIP}$	SENSE Pin Trip Voltage ($V_{CC} - V_{SENSE}$)	$FB = 0V$ $FB \geq 2V$ ●	7 45	14 55	22 65	mV mV
I_{INSNS}	SENSE Pin Input Current	$V_{SENSE} = V_{CC}$		40	70	μ A
I_{PU}	GATE Pull-Up Current	Charge Pump On, $\Delta V_{GATE} = 7V$ ●	–16	–32	–63	μ A
I_{PD}	GATE Pull-Down Current	Any Fault, $V_{GATE} > V_{OUT}$	40	62	80	mA
I_{PDL}	V_{OUT} Pull-Down Current, Fault Condition	Any Fault, $V_{GATE} = V_{OUT} + \Delta V_{GATEL}$, $V_{OUT} = 48V$		130		μ A
ΔV_{GATE}	External N-Channel Gate Drive (Note 2)	$V_{GATE} - V_{OUT}$, $10.8V \leq V_{CC} \leq 20V$ ● $20V \leq V_{CC} \leq 80V$ ●	4.5 10	8.8 11.6	12.5 12.8	V V
ΔV_{GATEL}	External N-Channel Gate Drive, Fault Condition	$V_{GATE} - V_{OUT}$, $V_{OUT} = 48V$		–2		V

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{CC} = 48\text{V}$ unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{FB}	FB Voltage Threshold	FB High-to-Low Transition	●	3.95	3.99	4.03	V
		FB Low-to-High Transition	●	4.20	4.45	4.65	V
V_{FBHYS}	FB Hysteresis Voltage			0.3	0.45	0.60	V
V_{OLPGD}	PWRGD Output Low Voltage	$I_O = 1.6\text{mA}$			0.25	0.4	V
		$I_O = 5\text{mA}$			0.60	1.0	V
I_{PWRGD}	PWRGD Pin Leakage Current	$V_{PWRGD} = 80\text{V}$			0.1	1	μA
I_{INFB}	FB Input Current	FB = 4.5V			-0.1	-1	μA
$I_{TIMERPU}$	TIMER Pull-Up Current	TIMER = 3V, During Fault	●	-63	-105	-147	μA
$I_{TIMERPD}$	TIMER Pull-Down Current	TIMER = 3V	●	1.5	3	5	μA
$V_{THTIMER}$	TIMER Shutdown Threshold	$C_{TIMER} = 10\text{nF}$	●	4.3	4.65	5	V
D_{TIMER}	Duty Cycle (RETRY Mode)		●	1.5	3	4.5	%
$V_{RETRYTH}$	RETRY Threshold		●	0.4	0.85	1.2	V
I_{INRTR}	RETRY Input Current	RETRY = GND			-87	-130	μA
t_{PHLUV}	UV Low to GATE Low	$C_{GATE} = 100\text{pF}$			1.7	3	μs
t_{PLHUV}	UV High to GATE High	$C_{GATE} = 100\text{pF}$			6	9	μs
t_{PHLFB}	FB Low to PWRGD Low				0.8	2	μs
t_{PLHFB}	FB High to PWRGD High				3.2	5	μs
$t_{PHLSENSE}$	$(V_{CC} - V_{SENSE})$ High to GATE Low	$V_{CC} - V_{SENSE} = 275\text{mV}$			1	3	μs

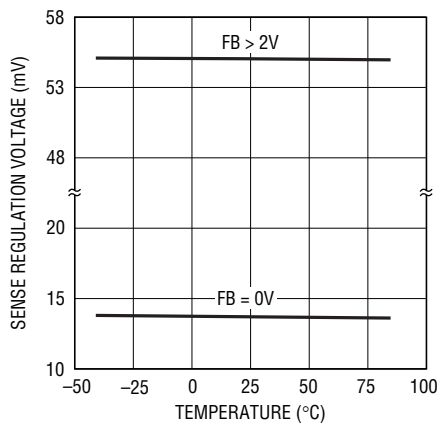
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: An internal clamp limits the GATE pin to a minimum of 10V above V_{CC} . Driving this pin to a voltage beyond the clamp voltage may damage the part.

TYPICAL PERFORMANCE CHARACTERISTICS

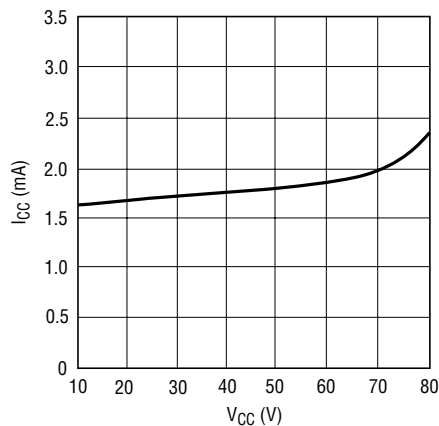
Specifications are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

SENSE Regulation Voltage vs Temperature



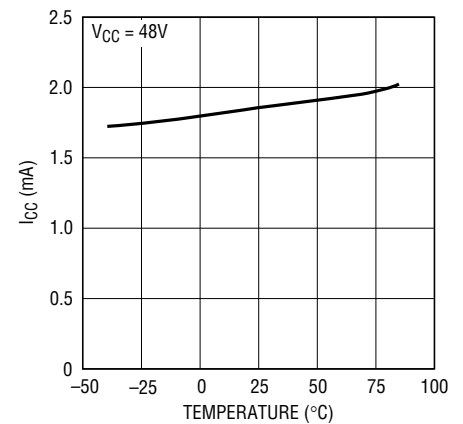
42563 G01

I_{CC} vs V_{CC}



42563 G02

I_{CC} vs Temperature

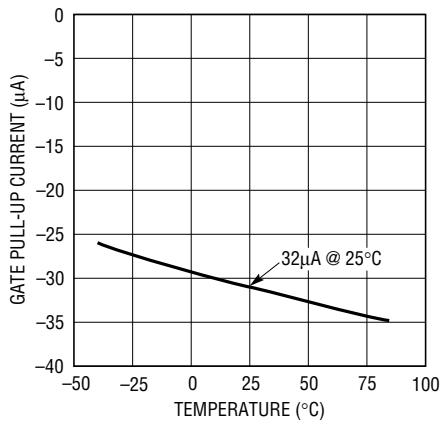


42563 G03

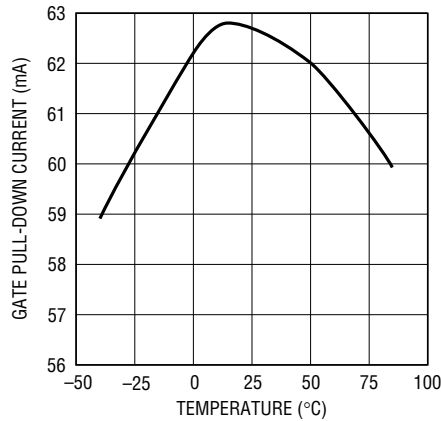
TYPICAL PERFORMANCE CHARACTERISTICS

Specifications are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

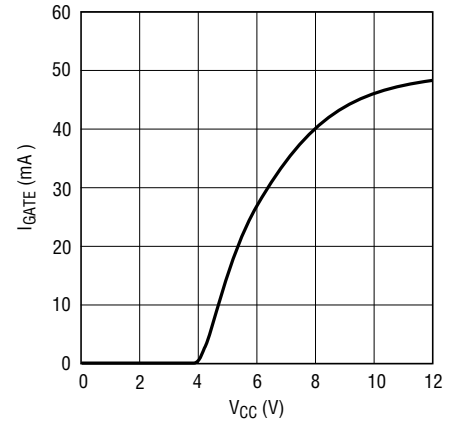
GATE Pull-Up Current vs Temperature



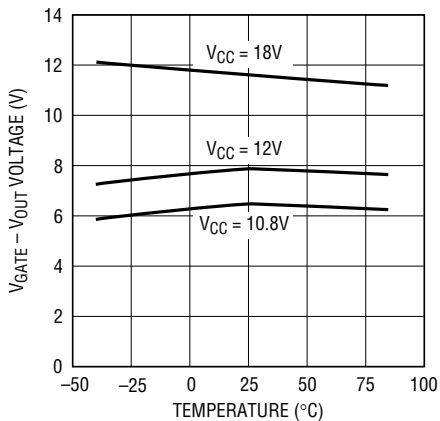
GATE Pull-Down Current vs Temperature



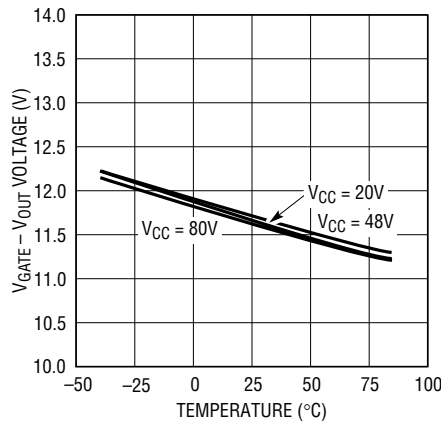
GATE Pull-Down Capability vs V_{CC} Below Minimum Operating Voltage



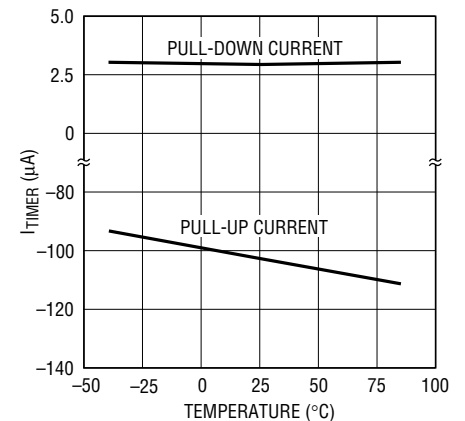
$V_{GATE} - V_{OUT}$ Voltage vs Temperature



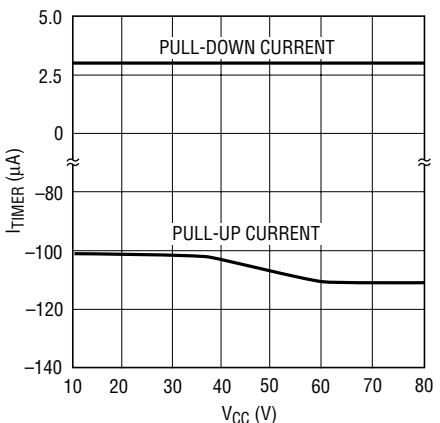
$V_{GATE} - V_{OUT}$ Voltage vs Temperature



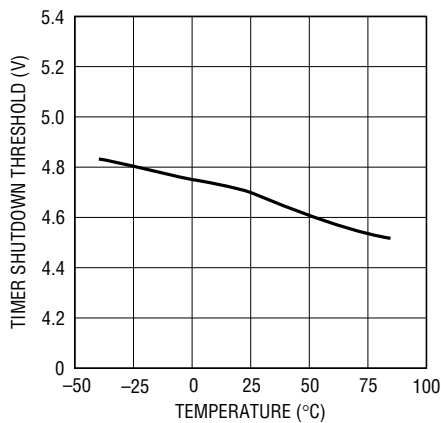
TIMER Currents vs Temperature



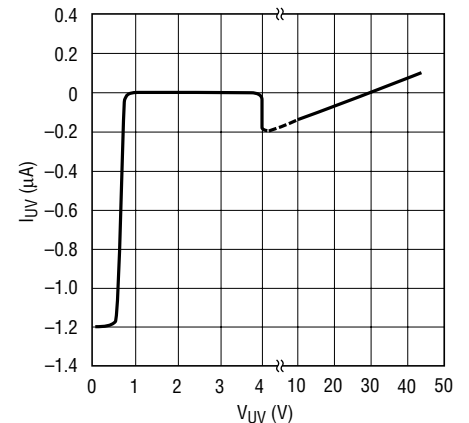
TIMER Currents vs V_{CC}



TIMER Shutdown Threshold vs Temperature



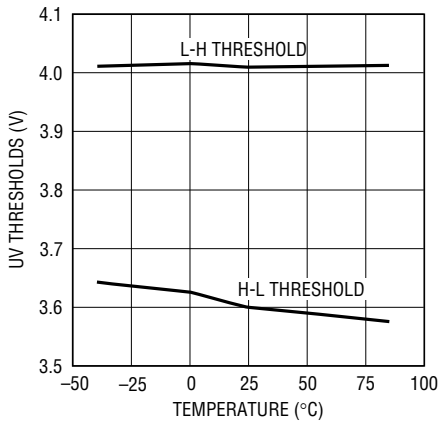
UV Current vs UV Voltage



TYPICAL PERFORMANCE CHARACTERISTICS

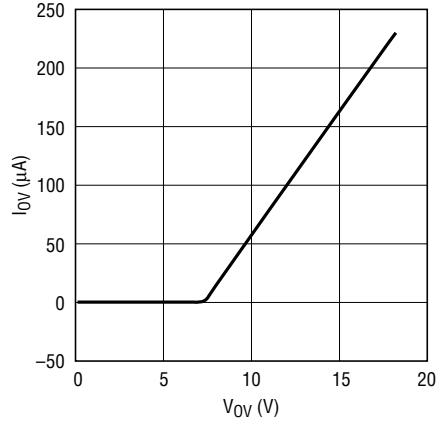
Specifications are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

UV Thresholds vs Temperature



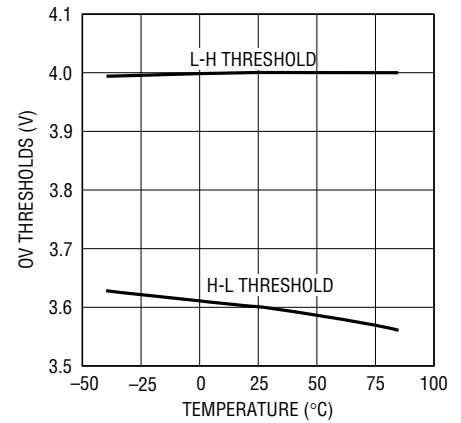
42563 G11

OV Current vs OV Voltage



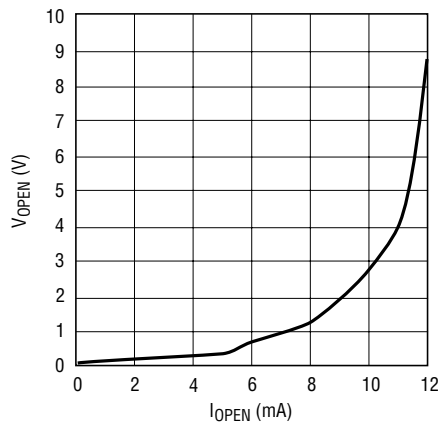
42563 G19

OV Thresholds vs Temperature



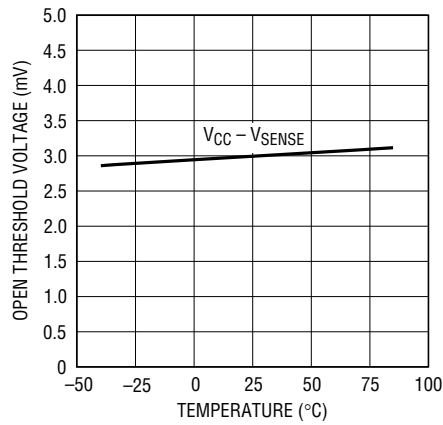
42563 G12

OPEN Output Voltage vs I_{OPEN}



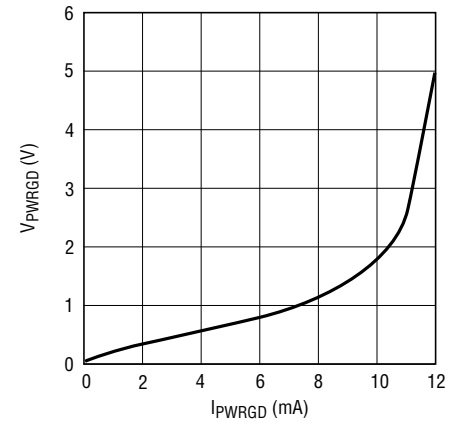
42563 G13

OPEN Threshold Voltage vs Temperature



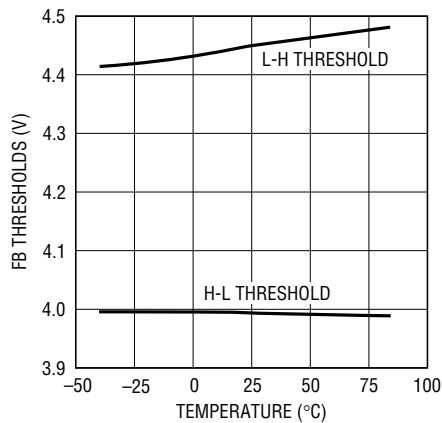
42563 G14

PWRGD Output Voltage vs I_{PWRGD}



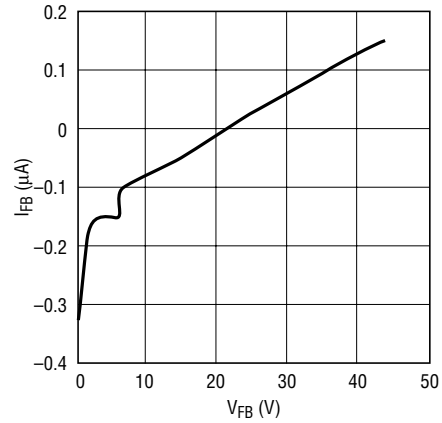
42563 G15

FB Thresholds vs Temperature



42563 G16

FB Current vs FB Voltage



42563 G20

PIN FUNCTIONS

UV (Pin 1): Undervoltage Sense Input. UV is an input that enables the output voltage. When UV is driven above 4V, GATE will start charging and the output turns on. When UV goes below 3.6V, GATE discharges and the output shuts off.

Pulsing UV to below 0.4V for at least 5 μ s after a current limit fault cycle resets the fault latch (when RETRY pin is low, commanding latch off operation) and allows the part to turn back on. This command is only accepted after TIMER is discharged below 0.65V. To disable UV sensing, connect the pin to a voltage between 5V and 44V.

OV (Pin 2): Overvoltage Sense Input. OV is an input that disables the output voltage. If OV ever goes above 4V, GATE is discharged and the output shuts off. When OV goes below 3.6V, GATE starts charging and the output turns back on. To disable overvoltage sensing, connect pin to ground.

NC (Pins 3, 6, 11, 14): No Connect. Not connected to any internal circuitry.

OPEN (Pin 4): Open Circuit Detect Output. This pin is an open collector output that releases and is pulled high through an external resistor if the load current is less than (3mV)/R5.

PWRGD (Pin 5): Power Good Output. PWRGD is pulled low whenever the voltage on FB falls below the high-to-low threshold voltage. It goes into a high impedance state when the voltage on FB exceeds the low-to-high threshold voltage. An external pull-up resistor can pull PWRGD to a voltage higher or lower than V_{CC} .

RETRY (Pin 7): Current Fault Retry Input. RETRY commands the operational mode of the current limit. If RETRY is floating, the LT4256-3 automatically restarts after a current fault. If it is connected to a voltage below 0.4V, it will latch off after a current fault (which requires that UV be cycled low in order to start normal operation again).

GND (Pin 8): Device Ground. This pin must be tied to a ground plane for best performance.

TIMER (Pin 9): Timing Input. An external timing capacitor from TIMER to GND programs the maximum time the part is allowed to remain in current limit. When the part goes into current limit, a 105 μ A pull-up current source starts to charge the timing capacitor. When the voltage on TIMER reaches 4.65V (typ), GATE is pulled low; the TIMER pull-up current will be turned off and the capacitor is discharged by a 3 μ A pull-down current. When TIMER falls below 0.65V (typ), GATE turns on again if RETRY is high (if RETRY is low, UV must be pulsed low to reset the internal fault latch before GATE will turn on). If RETRY is grounded and UV is not cycled low, GATE remains latched off and TIMER will be discharged to near ground. UV must be cycled low after TIMER has discharged below 0.65V (typ) to reset the part.

If RETRY is floating or connected to a voltage above its 1.2V threshold, the LT4256-3 automatically restarts after a current fault. Under an output short-circuit condition, the LT4256-3 cycles on and off with a 3% on-time duty cycle.

FB (Pin 10): Power Good Comparator Input. FB monitors the output voltage through an external resistive divider. When the voltage on FB is lower than the high-to-low threshold of 3.99V, PWRGD is pulled low and released when FB is pulled above the 4.45V low-to-high threshold.

The voltage present on FB affects foldback current limit (see Figure 8 and related discussion).

V_{OUT} (Pin 12): Output Voltage Sense Input. This pin should be connected to the source of the external MOSFET. It is used to sense when the MOSFET is shut off (during any fault mode) and to reduce the pull-down current on GATE. This protects the LT4256-3 from excessive power dissipation when large output capacitors are used.

PIN FUNCTIONS

GATE (Pin 13): High Side Gate Drive for the External N-Channel MOSFET. An internal charge pump guarantees at least 10V of gate drive for V_{CC} supply voltages above 20V and 4.5V of gate drive for V_{CC} supply voltages between 10.8V and 20V. The rising slope of the voltage on GATE is set by an external capacitor connected from GATE to GND and an internal 32 μ A pull-up current source from the charge pump output.

If the current limit is reached, the GATE voltage is adjusted to maintain a constant voltage across the sense resistor while the timing capacitor starts to charge. If the TIMER voltage ever exceeds 4.65V, GATE is pulled low.

GATE is also pulled to GND whenever UV is pulled low; the V_{CC} supply voltage drops below the externally programmed undervoltage threshold, above the overvoltage threshold or below the internal UVLO threshold (9.8V).

GATE is clamped internally to a maximum voltage of 11.6V (typ) above V_{OUT} under normal operating conditions. Driving this pin beyond the clamp voltage may damage the part. GATE is also clamped to 2V (typ) below V_{OUT} . When the gate is commanded off due to a fault condition, it is discharged quickly by a 62mA (typ)

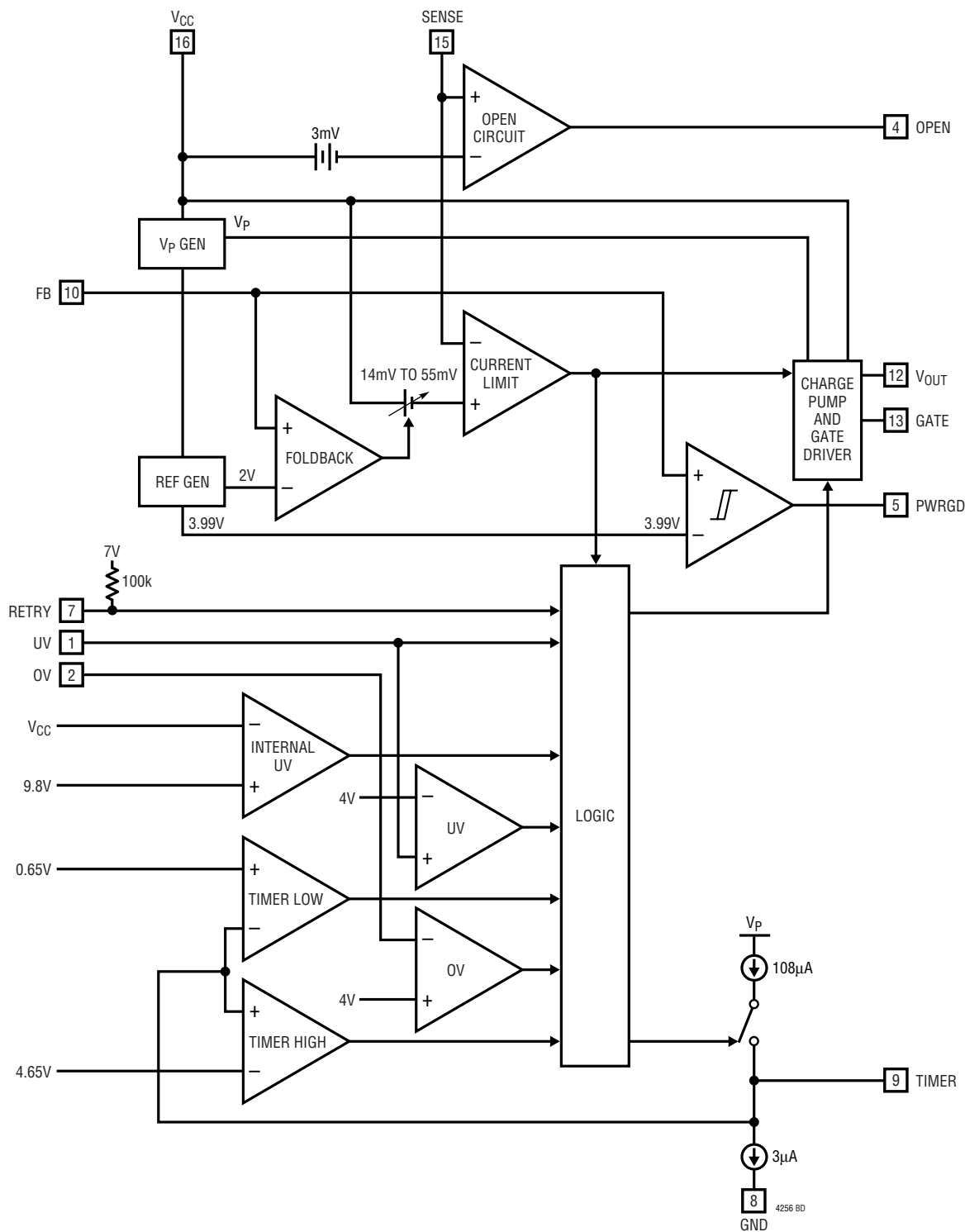
capable switch until GATE is 2V (typ) below V_{OUT} . When GATE is below V_{OUT} by 2V, the 62mA is reduced to 130 μ A to protect the LT4256-3 against damage if V_{OUT} has large capacitance. A Zener diode is needed between the gate and source of the external MOSFET to protect its gate oxide under instantaneous short-circuit conditions. See Applications Information.

SENSE (Pin 15): Current Limit Sense Input. A sense resistor is placed in the supply path between V_{CC} and SENSE. The current limit circuit regulates the voltage across the sense resistor ($V_{CC} - \text{SENSE}$) to 55mV while in current limit when FB is 2V or higher. If FB drops below 2V, the regulated voltage across the sense resistor decreases linearly and stops at 14mV when FB is 0V. The OPEN output also uses SENSE to detect when the output current is less than $(3\text{mV})/R_5$.

To defeat current limit, connect SENSE to V_{CC} .

V_{CC} (Pin 16): Input Supply Voltage. The positive supply input ranges from 10.8V to 80V for normal operation. I_{CC} is typically 1.8mA. An internal circuit disables the LT4256-3 for inputs less than 9.8V (typ).

BLOCK DIAGRAM



TEST CIRCUIT

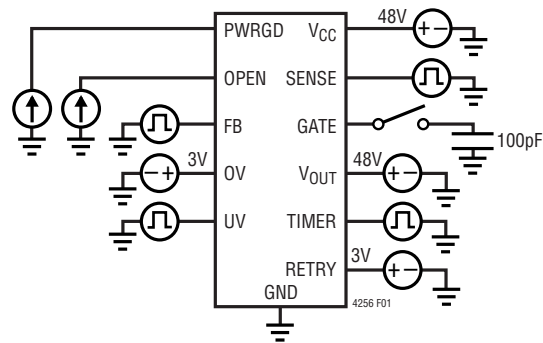


Figure 1

TIMING DIAGRAMS

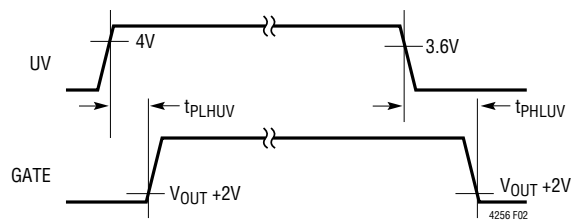


Figure 2. UV to GATE Timing

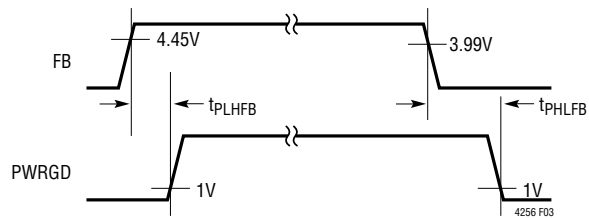


Figure 3. V_{OUT} to PWRGD Timing

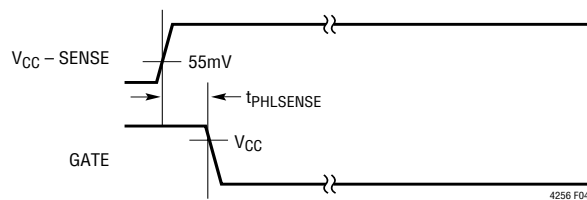


Figure 4. SENSE to GATE Timing

APPLICATIONS INFORMATION

Hot Circuit Insertion

When circuit boards are inserted into a live backplane, the supply bypass capacitors on the boards draw high peak currents from the backplane power bus as they charge. The transient currents can permanently damage the connector pins and glitch the system supply, causing other boards in the system to reset.

The LT4256-3 is designed to turn on a board's supply voltage in a controlled manner, allowing the board to be safely inserted or removed from a live backplane. The device also provides undervoltage and overvoltage as well as overcurrent protection while a power good output signal indicates when the output supply voltage is ready with a high output.

Power-Up Sequence

An external N-channel MOSFET pass transistor (Q1) is placed in the power path to control the power up of the supply voltage (Figure 5). Resistor R5 provides current detection and capacitor C1 controls the GATE slew rate. Resistor R7 compensates the current control loop while R6 prevents high frequency oscillations in Q1.

When the power pins first make contact, transistor Q1 is held off. If the voltage on V_{CC} is between the externally programmed undervoltage and overvoltage thresholds, V_{CC} is above 9.8V and the voltage on TIMER is less than 4.65V (typ), transistor Q1 will be turned on (Figure 6). The voltage on GATE rises with a slope equal to $32\mu A/C1$ and the supply inrush current is set at:

$$I_{INRUSH} = C_L \cdot 32\mu A/C1 \quad (1)$$

where C_L is the total load capacitance.

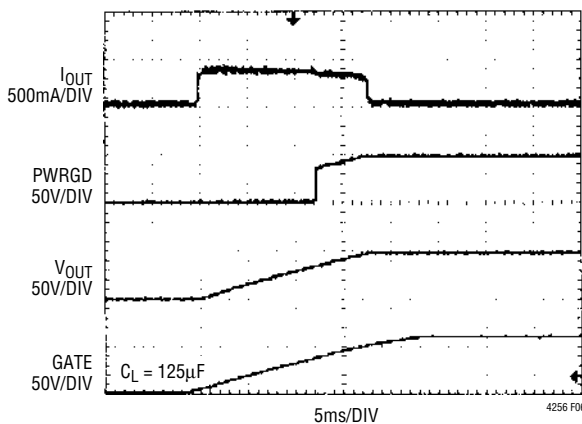


Figure 6. Start-Up Waveforms

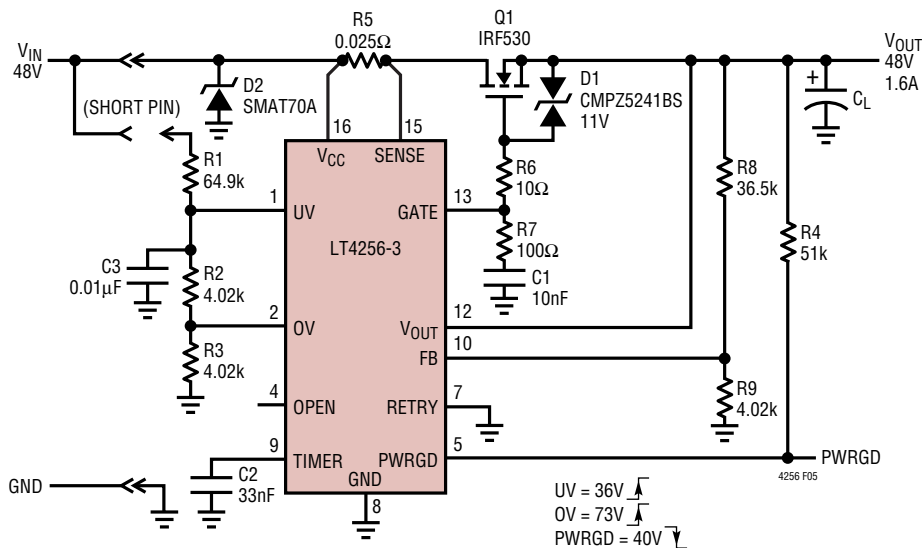


Figure 5. 1.6A, 48V Latchoff Application

APPLICATIONS INFORMATION

To reduce inrush current, increase C1 or decrease load capacitance. If the voltage across the current sense resistor R5 reaches $V_{SENSETRIP}$, the inrush current will be limited by the internal current limit circuitry. The voltage on GATE is adjusted to maintain a constant voltage across the sense resistor and TIMER begins to charge.

When the FB voltage goes above the low-to-high V_{FB} threshold, PWRGD goes high.

Undervoltage and Overvoltage Detection

The LT4256-3 uses UV and OV to monitor the V_{CC} voltage to determine when it is safe to turn on the load and allow the user the greatest flexibility for setting the operational thresholds. UV and OV are internally connected to an analog window comparator. Any time that UV goes below 3.6V or OV goes above 4V, GATE will be pulled low until the UV/OV voltages return to the normal operation voltage window (4V and 3.6V, respectively).

The UV threshold should never be set below the internal UVLO threshold (9.8V typically) because the benefit of the UV's hysteresis will be lost, making the LT4256-3 more susceptible to noise (V_{CC} must be at least 9.8V when UV is at its 3.6V threshold). UV is filtered with C3 to prevent

noise spikes and capacitively coupled glitches from shutting down the LT4256-3 output erroneously.

To calculate UV and OV thresholds, use the following equations:

$$R1 = (R2 + R3) \left(\frac{V_{THUVLH}}{4V} - 1 \right) \quad (2a)$$

$$R3 = \frac{R1 + R2}{\frac{V_{THOVLH}}{4} - 1} \quad (2b)$$

$$20k\Omega \leq R1 + R2 + R3 \leq 200k\Omega \quad (3)$$

$$V_{THUVHL} = 3.6V \left(1 + \frac{R1}{R2 + R3} \right); \quad (4)$$

$$V_{THOVLH} = 3.6V \left(1 + \frac{R1 + R2}{R3} \right)$$

where V_{THULH} and V_{THOVLH} are the desired UV and OV threshold voltages when V_{CC} is rising (L – H).

Figure 7 shows how the LT4256-3 is commanded to shut off with a logic signal. This is accomplished by pulling the gate of the open-drain MOSFET, Q2, (tied to UV) high.

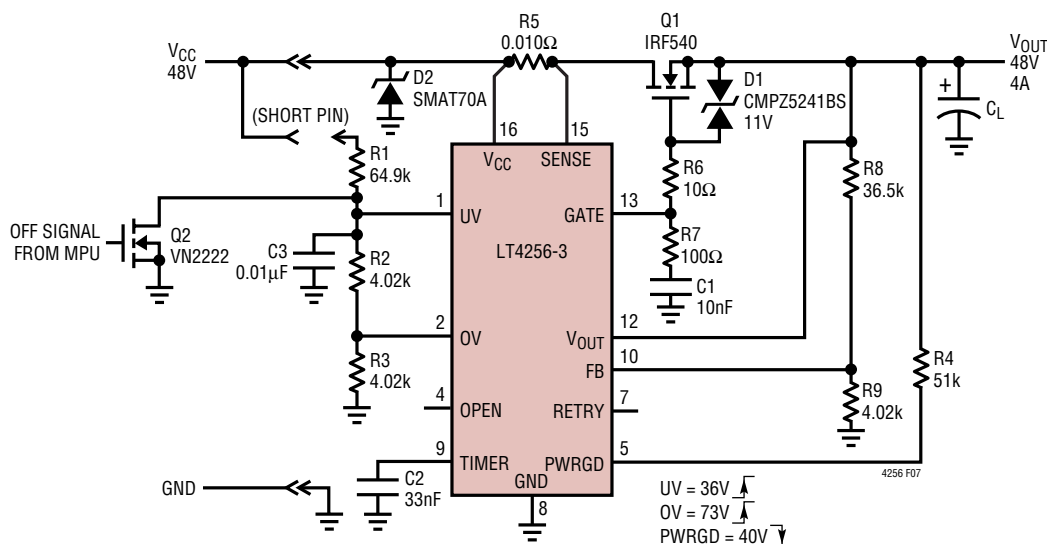


Figure 7. How to Use a Logic Signal to Control the LT4256-3 Turn On/Off

APPLICATIONS INFORMATION

Short-Circuit Protection

The LT4256-3 features a programmable foldback current limit with an electronic circuit breaker that protects against short circuits or excessive load currents. The current limit is set by placing a sense resistor (R5) between V_{CC} and SENSE. The current limit threshold is calculated as:

$$I_{LIMIT} = 55\text{mV}/R5 \quad (5)$$

To limit excessive power dissipation in the pass transistor and to reduce voltage spikes on the input supply during short-circuit conditions at the output, the current folds back as a function of the output voltage, which is sensed internally on FB.

If the LT4256-3 goes into current limit when the voltage on FB is 0V, the current limit circuit drives GATE to force a constant 14mV drop across the sense resistor. As the output at FB increases, the voltage across the sense resistor increases until FB reaches 2V, at which point the

voltage across the sense resistor is held constant at 55mV (see Figure 8).

For a 0.025Ω sense resistor, the typical current limit is set at 2200mA and folds back to 560mA when the output is shorted to ground. Thus, MOSFET peak power dissipation under short-circuit conditions is reduced from 106W to 27W. See the Layout Considerations section for important information about board layout to minimize current limit threshold error.

The LT4256-3 also features a variable overcurrent response time. The time required for the part to regulate the GATE voltage is a function of the voltage across the sense resistor connected between V_{CC} and SENSE. This helps to eliminate sensitivity to current spikes and transients that might otherwise unnecessarily trigger a current limit response and increase MOSFET dissipation. Figure 9 shows the response time as a function of the overdrive at SENSE.

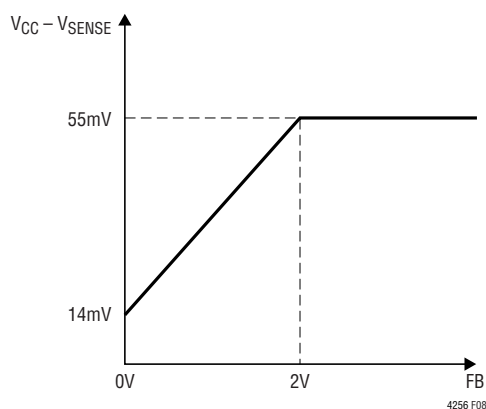


Figure 8. Current Limit Sense Voltage vs Feedback Pin Voltage

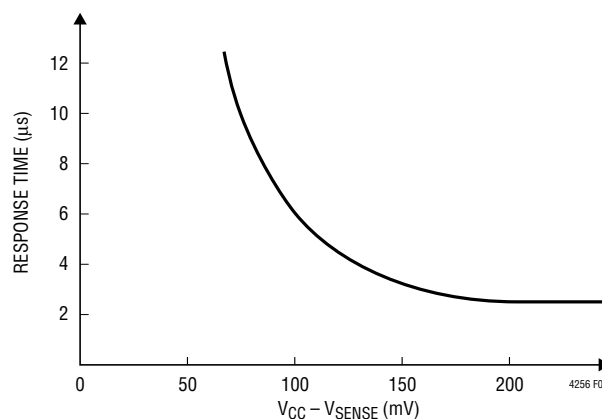


Figure 9. Response Time to Overcurrent

APPLICATIONS INFORMATION

TIMER

TIMER provides a method for programming the maximum time the part is allowed to operate in current limit. When the current limit circuitry is not active, TIMER is pulled to GND by a 3 μ A current source. When the current limit circuitry becomes active, a 108 μ A pull-up current source is connected to TIMER and the voltage will rise with a slope equal to 105 μ A/C_{TIMER} as long as the circuitry stays active. Once the desired maximum current limit time is known, the capacitor value is:

$$C[\text{nF}] = 25 \cdot t[\text{ms}]; C = \frac{105\mu\text{A}}{4.65\text{V}} \cdot t \quad (6)$$

Whenever TIMER reaches 4.65V (typ), the internal fault latch is set causing GATE to be pulled low and TIMER to be discharged to GND by the 3 μ A current source. The part is not allowed to turn on again until the voltage on TIMER falls below 0.65V (typ).

Whenever GATE is commanded off by any fault condition, it is discharged with a high current, turning off the external MOSFET. The waveform in Figure 10 shows how the output latches off following a current fault. The drop

across the sense resistor is held at 55mV as the timer ramps up. Once TIMER reaches its shutdown threshold (4.65V typically), the circuit latches off.

Automatic Restart

If RETRY is floating, then the device automatically restarts after a current overload fault.

When the voltage at TIMER ramps back down to 0.65V (typ), the LT4256-3 turns on again. If the short-circuit condition at the output still exists, the cycle will repeat itself indefinitely. The duty cycle under short-circuit conditions is 3% which prevents Q1 from overheating. Figure 11 shows representative waveforms during a short circuit.

Latch Off Operation

If RETRY is grounded, the LT4256-3 will latch off after a current fault. After the part latches off, it may be commanded to start back up. This is accomplished by cycling UV to ground and then back high (this command can only be accepted after TIMER discharges below the 0.65V typ threshold, which prevents overheating transistor Q1).

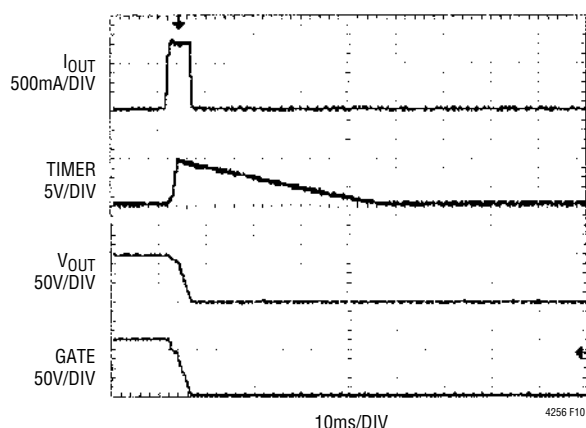


Figure 10. Latch Off Waveforms

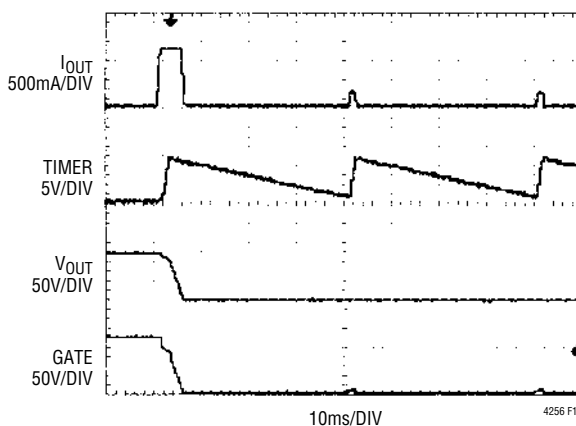


Figure 11. RETRY Waveforms

APPLICATIONS INFORMATION

This open FET condition can be falsely signalled during start-up if the load is not activated until after PWRGD goes high. To avoid this false indication, OPEN and PWRGD should not be polled for a period of time, t_{STARTUP} , given by:

$$t_{\text{STARTUP}} = \frac{3 \cdot V_{\text{CC}} \cdot C1}{32\mu\text{A}} \quad (9)$$

This can be accomplished either by a microcontroller (if available) or by placing an RC filter as shown in Figure 13.

Once the OPEN voltage exceeds the monitoring logic threshold, V_{THRESH} , and PWRGD is low, an open FET condition is signalled. In order to prevent a false indication, the RC product should be set with the following equation:

$$RC > \frac{3 \cdot V_{\text{CC}} \cdot C1}{32\mu\text{A} \left(\ln \left(\frac{V_{\text{LOGIC}}}{V_{\text{LOGIC}} - V_{\text{THRESH}}} \right) \right)} \quad (10)$$

Another condition that can cause a false indication is if the LT4256-3 goes into current limit during start-up. This will cause t_{STARTUP} to be longer than calculated. Also, if the LT4256-3 stays in current limit long enough for TIMER to fully charge up to its threshold, the LT4256-3 will either latch off (RETRY = 0) or go into the current limit hiccup mode (RETRY = floating). In either case, an open FET condition will be falsely signalled. If the LT4256-3 does go into current limit during start-up, C1 can be increased (see Power-Up Sequence).

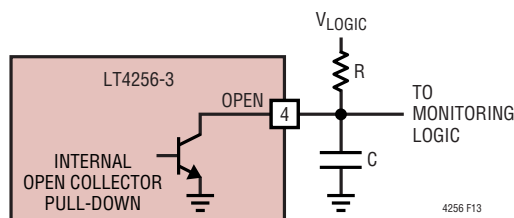


Figure 13. Delay Circuit for OPEN FET Detection

Supply Transient Protection

The LT4256-3 is 100% tested and guaranteed to be safe from damage with supply voltages up to 80V. However, voltage transients above 100V may cause permanent damage. During a short-circuit condition, the large change in currents flowing through the power supply traces can cause inductive voltage transients which could exceed 100V. To minimize the voltage transients, the power trace parasitic inductance should be minimized by using wider traces or heavier trace plating and a bypass capacitor should be placed between V_{CC} and GND. A surge suppressor (TransZorb®) at the input can also prevent damage from voltage transients.

GATE Pin

A curve of gate drive vs V_{CC} is shown in Figure 14. GATE is clamped to a maximum voltage of 12.8V above V_{OUT} . This clamp is designed to withstand the internal charge pump current. An external Zener diode must be used as shown in all applications. At a minimum input supply voltage of 10.8V, the minimum gate drive voltage is 4.5V. When the input supply voltage is higher than 20V, the gate drive voltage is at least 10V and a standard threshold MOSFET can be used. In applications from 12V to 15V range, a logic level MOSFET must be used.

TransZorb is a registered trademark of General Instruments, GSI.

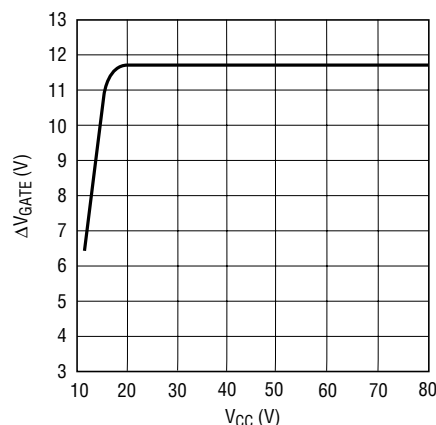


Figure 14. ΔV_{GATE} vs V_{CC}

APPLICATIONS INFORMATION

In some applications it may be possible for V_{OUT} to ring below ground (due to the parasitic trace inductance). Higher current applications, especially where the output load is physically far away from the LT4256-3 will be more susceptible to these transients. This is normal and the LT4256-3 has been designed to allow for some ringing below ground. However, if the application is such that V_{OUT} can ring more than 3V below ground, damage may occur to the LT4256-3 and an external diode, D2, from ground (anode) to V_{OUT} (cathode) will have to be added to the circuit as shown in Figure 15 (it is critical that the reverse breakdown voltage of the diode be higher than the highest expected V_{CC} voltage). A capacitor placed from ground to V_{OUT} directly at the LT4256-3 pins can help reduce the amount of ringing on V_{OUT} but it may not be enough for some applications.

During a fault condition, the LT4256-3 pulls down on GATE with a switch capable of sinking about 62mA. Once GATE drops below the output voltage by a diode forward voltage, the external Zener will forward bias and V_{OUT} will also be discharged to GND. In addition to the GATE capacitance, the output capacitance will be discharged through the LT4256-3.

In applications utilizing very large external N-channel MOSFETs, the possibility exists for the MOSFET to turn on when initially inserted into a live backplane (before the

LT4256-3 becomes active and pulls down on GATE). This is due to the MOSFET intrinsic drain to gate capacitance forcing current into R7 and C1 when the drain voltage steps up from ground to V_{CC} with an extremely fast rise time. To alleviate this situation, a diode, D3, should be put across R7 with the cathode connected to C1 as shown in Figure 16.

Whenever the LT4256-3 turns the MOSFET off, GATE pulls the MOSFET gate to ground with an open collector capable of sinking 62mA. If the output is held up by a large reservoir capacitor, the stored energy is dissipated in the pull-down transistor via a sneak path through the (now forward biased) Zener, D1. The LT4256-3 has a proprietary feature that reduces on-chip power dissipation by sensing when the MOSFET is off and reducing the pull-down current significantly. See V_{GATE} Turn-Off for more information about using this feature.

V_{GATE} Turn-Off

The LT4256-3 has a proprietary feature that reduces power dissipation by sensing when the MOSFET is off and reducing the pull-down current significantly. As the GATE pin is discharged during any fault, the LT4256-3 monitors the GATE pin and V_{OUT} pin. When the GATE pin is 2V below V_{OUT} , the pull-down current is reduced from 62mA to about 130 μ A.

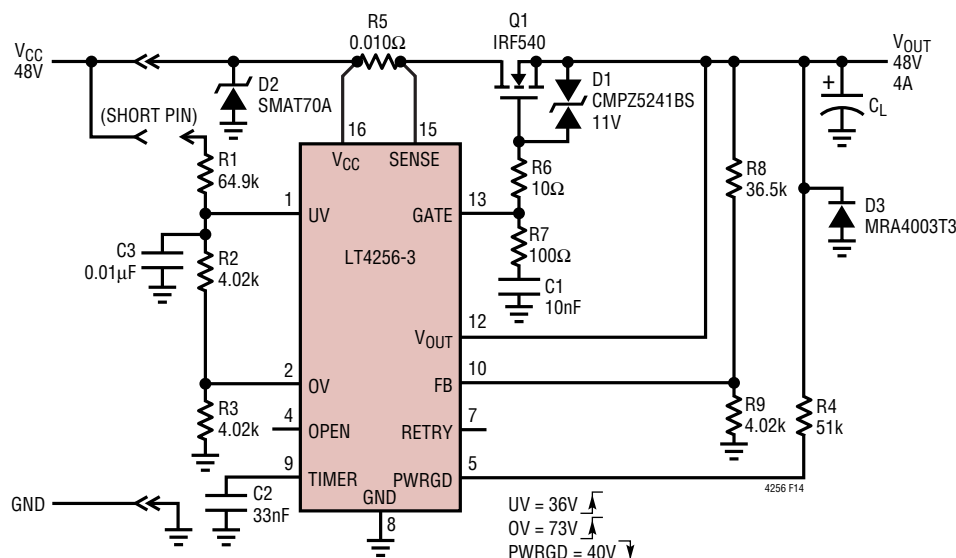


Figure 15. Negative Output Voltage Protection Diode Application

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$$I_{MAX} = \frac{7000}{R_{PROG}} (350\mu A) \quad (12)$$


APPLICATIONS INFORMATION

Layout Considerations

To achieve accurate current sensing, a Kelvin connection to the current sense resistor (R5 in typical application circuit) is recommended. Note that 1oz copper exhibits a sheet resistance of about $530\mu\Omega/\square$. Small resistances can cause large errors in high current applications. Noise

immunity will be improved significantly by locating resistor dividers close to the pins with short V_{CC} and GND traces. The minimum trace width for 1oz copper foil is 0.02" per amp to make sure the trace stays at a reasonable temperature. 0.03" per amp or wider is recommended. Figure 18 shows a layout that meets these requirements.

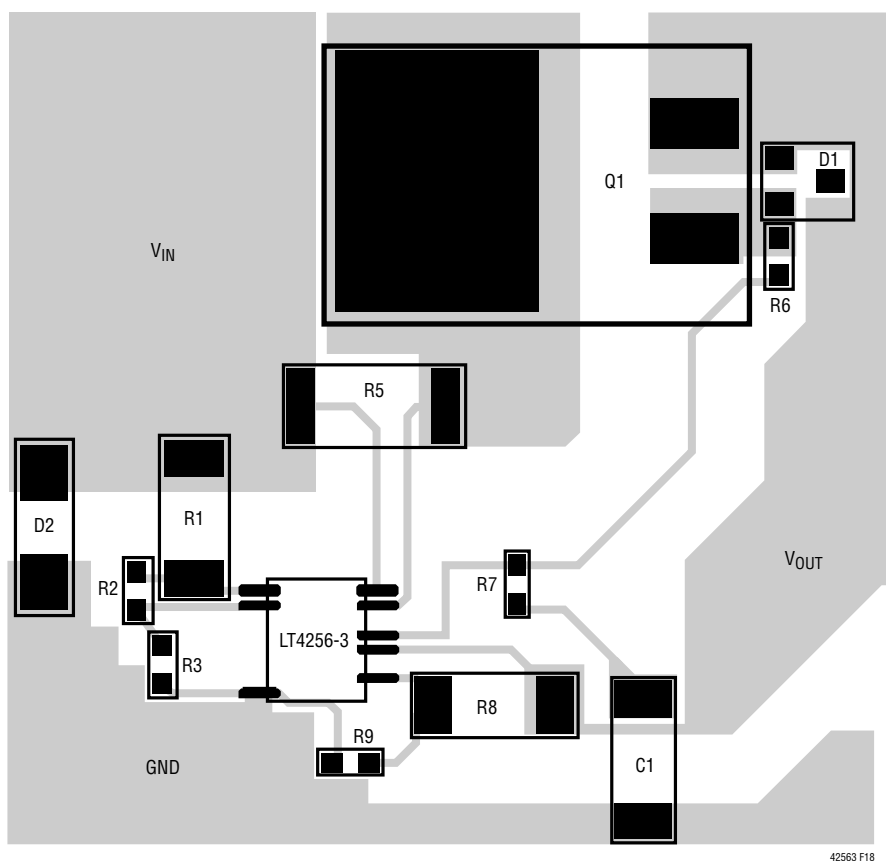
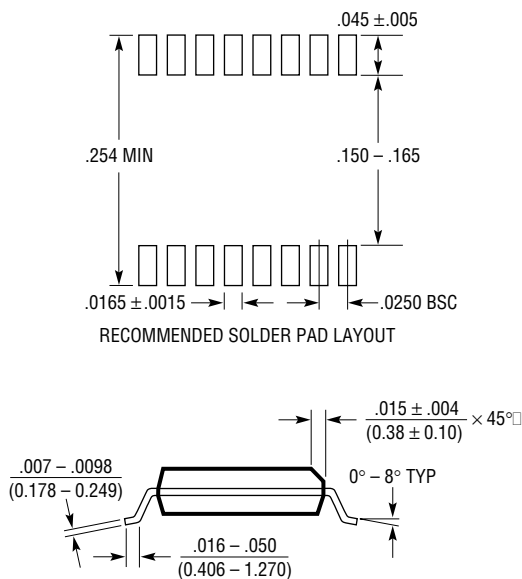


Figure 18. Recommended Component Placement

42563 F18

PACKAGE DESCRIPTION

GN Package 16-Lead Plastic SSOP (Narrow .150 Inch) (Reference LTC DWG # 05-08-1641)

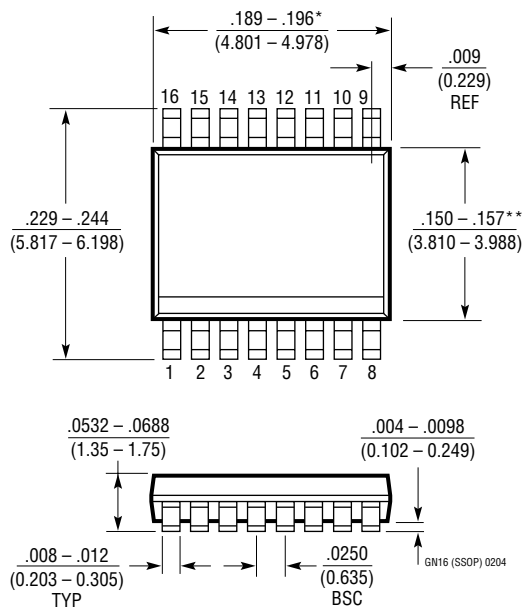


NOTE:

1. CONTROLLING DIMENSION: INCHES
2. DIMENSIONS ARE IN $\frac{\text{INCHES}}{\text{MILLIMETERS}}$
3. DRAWING NOT TO SCALE

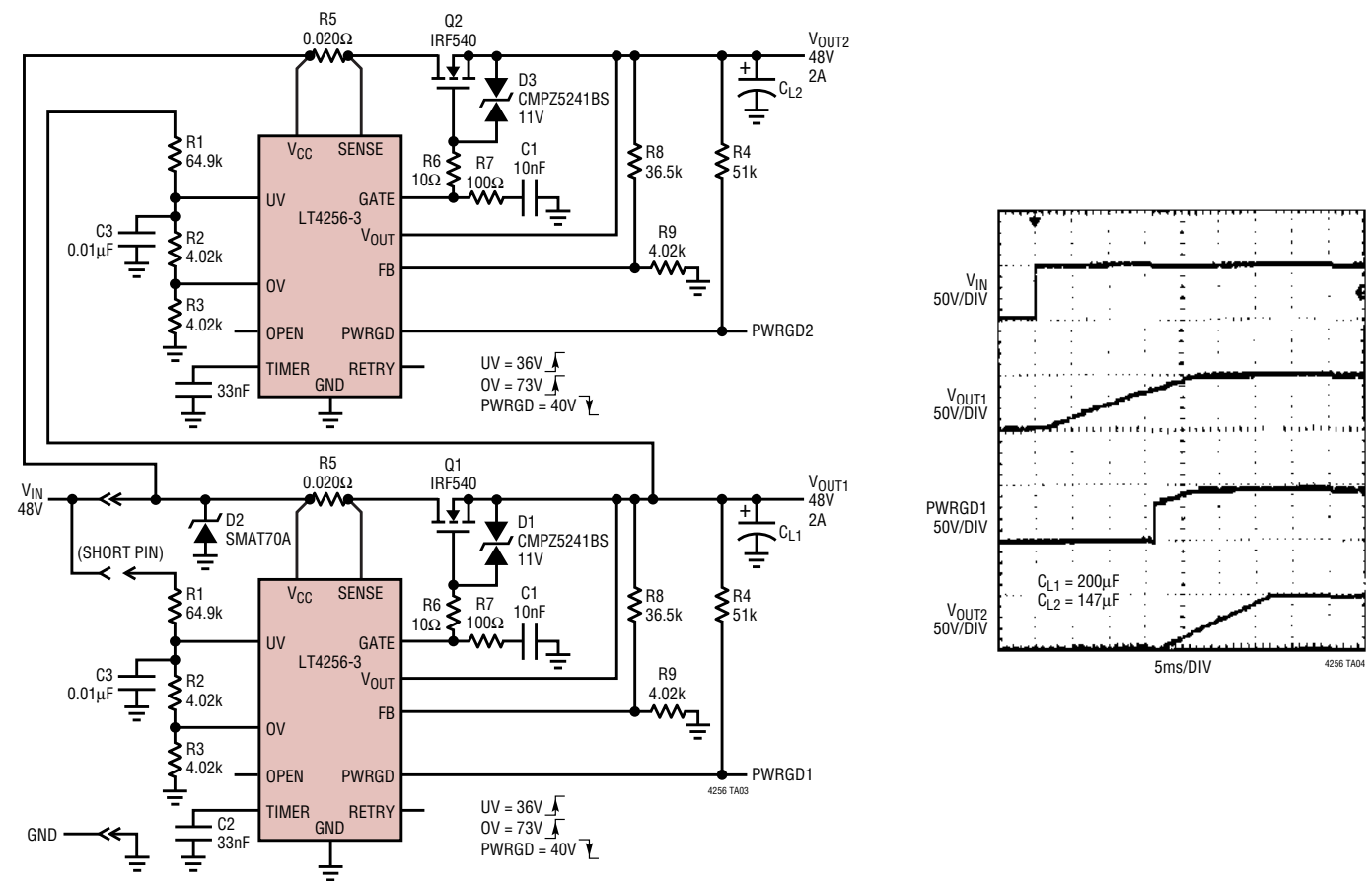
*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED $0.006''$ (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED $0.010''$ (0.254mm) PER SIDE



APPLICATIONS INFORMATION

Dual 48V Supply Sequencing Application



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1641-1/LT1641-2	Positive 48V Hot Swap Controller in SO-8	9V to 80V Operation, Active Current Limit, Autoretry/Latchoff
LTC4211	Single Hot Swap Controller with Multifunction Current Control	2.5V to 16.5V, Active Inrush Limiting, Dual Level Circuit Breaker
LTC4251	–48V Hot Swap Controller in SOT-23	Floating Supply from –15V, Active Current Limiting, Fast Circuit Breaker
LTC4252-1/LTC4252-2	–48V Hot Swap Controller in MSOP	Floating Supply from –15V, Active Current Limiting, Power Good Output
LTC4253	–48V Hot Swap Controller and Supply Sequencer	Floating Supply from –15V, Active Current Limiting, Enables Three DC/DC Converters
LT4254	Positive High Voltage Hot Swap Controller	10.8V to 36V Operation, Open-Circuit Detection
LT4256-1/LT4256-2	Positive High Voltage Hot Swap Controller	10.8V to 80V Operation, Active Current Limit, Autoretry/Latchoff